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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 09/687,600  
Filing Date October 12, 2000  
Inventor Jason E. Tripard  
Assignee Micron Technology, Inc.  
Group Art Unit 3724  
Examiner Stephen Choi  
Attorney's Docket No. MI22-1550  
Title: Integrated Circuit Package Separators

**RESPONSE TO FINAL OFFICE ACTION DATED MARCH 21, 2002**  
**TO ACCOMPANY RCE FILING**

To: Box RCE  
Assistant Commissioner for Patents  
Washington, D.C. 20231

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RECEIVED  
JUN 26 2002  
IC 3700 MAIL ROOM

**AMENDMENTS**

**In the Specification**

Please replace the paragraph on page 10, beginning at line 12, with the following clean replacement paragraph in accordance with 37 C.F.R. § 1.121(b)(1)(ii):

--Panels 132, 134 and 136 comprise ribs 140, 142 and 144, respectively (only some of which are labeled). Ribs 140, 142 and 144 can assist in supporting board assembly 10. Specifically, IC chips 12 are frequently provided on both an upper surface of circuit board assembly 10, and a bottom surface (not shown). Ribs 140, 142 and 144 (also referred to as blocks) have upper